

**L6254**

12V DISK DRIVE SPINDLE & VCM, POWER & CONTROL "COMBO"

PRODUCT PREVIEW

GENERAL

- 12V ($\pm 10\%$) OPERATION.
- REGISTER BASED ARCHITECTURE
- MINIMUM EXTERNAL COMPONENTS
- BICMOS + VERTICAL DMOS (1.5mm)

VCM DRIVER

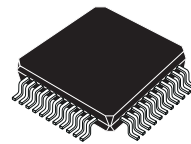
- 1.5A DRIVE CAPABILITY
- 0.9W TOTAL BRIDGE IMPEDANCE AT 25°C
- LINEAR MODE
- PHASE SHIFT MODULATION (PWM MODE)
- INSTANTANEOUS, (GLICH FREE) SWITCH BETWEEN THE 2 MODES
- CLASS AB OUTPUT DRIVERS
- ZERO CROSSOVER DISTORSION
- 14 BIT DAC DEFINE OUTPUT CURRENT
- SELECTABLE TRANSCONDUCTANCE
- 4 PROGRAMMABLE PARKING VOLTAGE
- DYNAMIC BRAKE

SPINDLE DRIVER

- 2.0A DRIVE CAPABILITY
- 0.8W TOTAL BRIDGE IMPEDANCE AT 25°C
- BEMF, INTERNAL OR EXTERNAL, PROCESSING
- SENSOR-LESS MOTOR COMMUTATION
- PROGRAMMABLE COMMUTATION PHASE DELAY
- LINEAR MODE AND CONSTANT TOFF PWM OPERATION MODE
- INTERNAL FREQUENCY LOCKED LOOP SPEED CONTROL (FLL)
- BEMF RECTIFICATION DURING RETRACT
- BUILT-IN ALIGNMENT&GO START-UP
- INDUCTIVE SENSING START UP OPTION
- RESYNCHRONIZATION
- DYNAMIC & REVERSE BRAKE
- CONTROLLABLE OUTPUT SLEW RATE

OTHER FUNCTIONS

- 12V AND 5V MONITORING WITH EXTERNAL SET TRIP POINTS AND HYSTERESIS
- POWER UP/DOWN SEQUENCING
- LOW VOLTAGE SENSE

BICMOS TECHNOLOGY

TQFP44 (10x10mm)

ORDERING NUMBER: L6254

- SLUG FOR POWER DISSIPATION
- THERMAL SHUTDOWN AND PRETHERMAL WARNING

DESCRIPTION

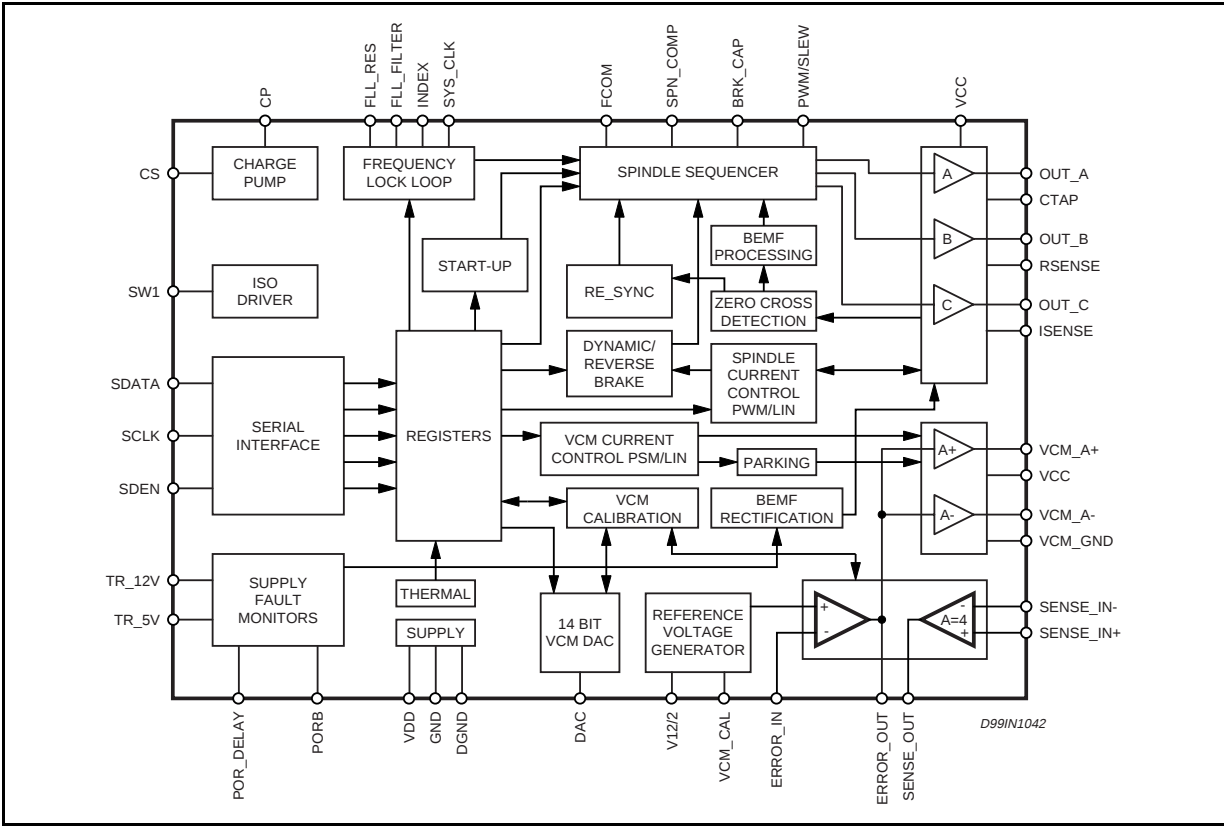
The L6254 integrates into a single chip both spindle and VCM controllers as well as power stages. The device is designed for 12V disk drive application requiring up to 2.0A of spindle and 1.5A of VCM peak currents.

A serial port with up to 25 MHz capability provides easy interface to the microprocessor. A register controlled Frequency Locked Loop (FLL) allows flexibility in setting the spindle speed. Integrated BEMF processing, digital masking, digital delay, and sequencing minimize the number of external components required.

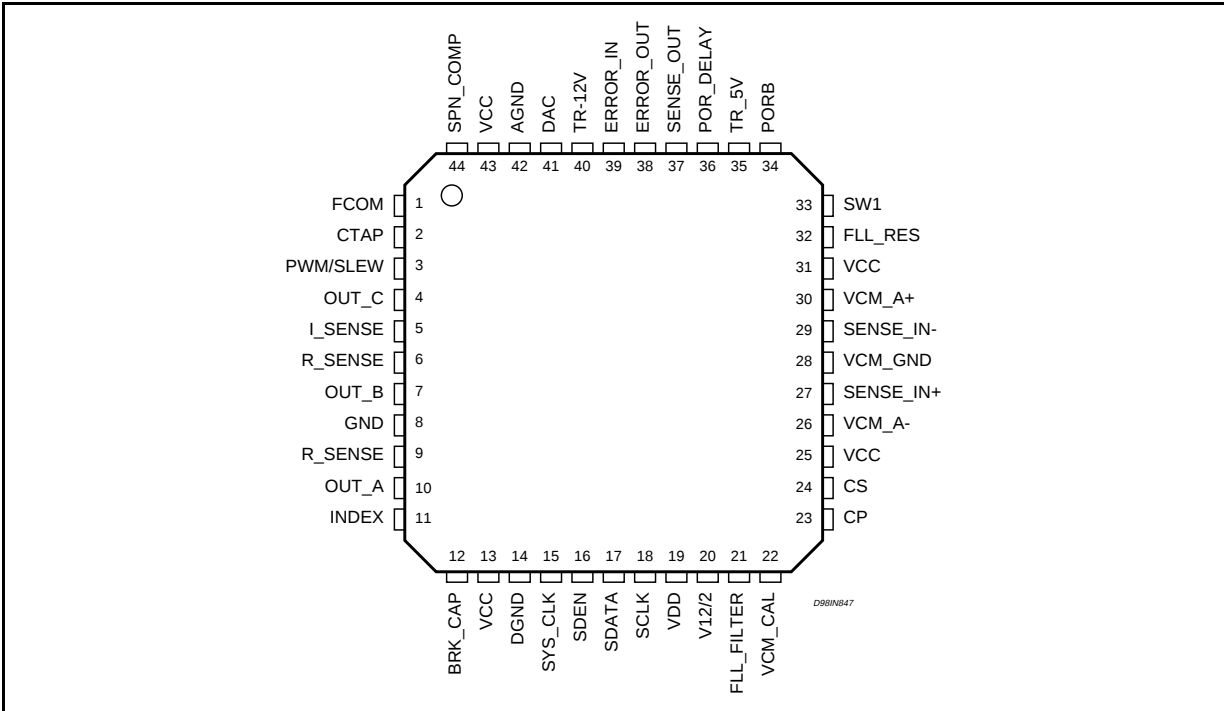
Power On Reset (POR) circuitry is included. Upon detection of a low voltage condition, POR is asserted, the internal registers are reset, and spindle power circuitry is tri-stated. The BEMF is rectified providing power for actuator retraction followed by dynamic spindle braking.

The device is built in BICMOS technology allowing dense digital/analog circuitry to be combined with a high power DMOS output stage.

BLOCK DIAGRAM



PIN CONNECTION



PIN DESCRIPTION (Pin Types: D = Digital, P = Power, A = Analog)

N.	Name	Function
1	FCOM	Output of the Spindle zero cross or Current Sense circuit.
2	CTAP	Spindle Central Tap used for differential BEMF sensing.
3	PWM/SLEW	RC network sets the Spindle Linear Slew Rate and PWM OFF-Time.
4	OUT_C	Spindle DMOS Half Bridge Output and Input C for BEMF sensing.
5	I_SENSE	Input to sense the voltage the SPINDLE Sense Resistor.
6	R_SENSE	Output connection for the Motor Current Sense Resistor to ground.
7	OUT_B	Spindle DMOS Half Bridge Output and Input B for BEMF sensing.
8	GND	Spindle Ground (Substrate).
9	R_SENSE	Output connection for the Motor Current Sense Resistor to ground.
10	OUT_A	Spindle DMOS Half Bridge Output and Input A for BEMF sensing.
11	INDEX	Input to allow Spindle to be locked to Index (servo) pulse.
12	BRK_CAP	Storage Capacitor for brake circuit. typically 5.9V.
13	VCC	+12V Power Supply for Spindle Power section.
14	DGND	Digital Ground.
15	SYS_CLK	Clock Frequency for system timers and counters.
16	SDEN	Serial Data Enable. Active high input pin for the serial port enable.
17	SDATA	Serial Port Data. Input/Output pin for serial data, 8bits of instruction/address followed by 8 bits of data. Open pin is at logic low as an input.
18	SCLK	Serial Port Data Clock. Positive edge triggered clock input for the serial data.
19	VDD	Digital/Analog power supply. +5V nominally.
20	V12/2	Reference Output for VCM control loop. Typically, half of the VCC except when parking.
21	FLL_FILTER	Speed loop R/C compensation connection used for FLL mode operation.
22	VCM_CAL	VCM loop offset voltage used for calibration.
23	CP	External Main Charge Pump Capacitor, Typically, Vz+Vcc is about 17.8V
24	CS	External Charge Pump Capacitor.
25	VCC	+12V Power Supply for VCM Power section.
26	VCM_A-	VCM Power Amplifier negative output terminal.
27	SENSE_IN+	Non inverting Input of the Sense Amplifier for VCM block.
28	VCM_GND	Ground for VCM Power section.
29	SENSE_IN-	Inverting Input of the Sense Amplifier for VCM block.
30	VCM_A+	VCM Power Amplifier positive output terminal.
31	VCC	+12V Power Supply for VCM Power section.
32	FLL_RES	Resistor for setting accurate bias current sources for the chip (62K required).
33	SW1	External ISOFET driver.
34	PORB	Power on Reset Output. Low signal indicates the failure of the supplies.
35	TR_5V	Set Point Input for 5V Supply Monitor (2V threshold, 100mV Hysteresis)
36	POR_DELAY	Capacitor connection to set the Power on Reset Delay (3V threshold, 2μA charging)
37	SENSE_OUT	Output of the Sense Amplifier.
38	ERROR_OUT	Output of the Error Amplifier.
39	ERROR_IN	Inverting Input of the Error Amplifier.
40	TR_12V	Set Point Input for 12V Supply Monitor (2V threshold, 100mV Hysteresis)
41	DAC	Output of the VCM DAC.
42	AGND	Analog Ground. For bang gap voltage reference.
43	VCC	+12V Power Supply for Spindle Power section.
44	SPN_COMP	External RC network that defines the compensation of the Spindle Transconductance Loop in Linear Mode.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Maximum Supply voltage	-0.5 to 14	V
V_{dd}	Maximum Logic supply	-0.5 to 6	V
$V_{in\ max}$	Maximum digital input voltage	$V_{dd} + 0.3V$	V
$V_{in\ min}$	Minimum digital input voltage	GND - 0.3V	V
SPINDLE I_{peak}	Spindle peak sink/source output current	2.1	A
VCM I_{peak}	VCM peak sink/source output current	1.6	A
$P_{tot}\ (*)$	Maximum Total Power Dissipation	≈ 1.7	W
T_{stg}, T_j	Maximum Storage/Junction Temperature	-40 to 150	°C

THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th\ j-case}$	Thermal Resistance Junction to Case	≈ 20	°C/W
$R_{th\ j-amb}\ (*)$	Thermal Resistance to Junction to ambient	≈ 40 ≈ 25 with soldered slug	°C/W °C/W

(*) In typical application with multilayer 120x120mm Printed Circuit Board.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	10.8 to 13.2	V
V_{dd}	Maximum Logic supply	4.5 to 5.5	V
T_{amb}	Operating Ambient Temperature	0 to 70	°C
T_j	Junction Temperature	0 to 125	°C

ELECTRICAL CHARACTERISTICS (All specifications are for $0 < T_{amb} < 70^\circ\text{C}$, $V_{CC} = 12V$; $V_{DD} = 5V$, $FLL_RES = 62k\Omega$, unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
POWER SUPPLIES						
V_{CC}	12V Supply		10.8		13.2	V
I_{VCC}	V_{CC} Current	SPINDLE + VCM		20		mA
		SPINDLE ONLY		7		mA
		VCM ONLY		12		mA
$V_{rectified}$	V_{CC} Supply Rectified		3.5		13.2	V
V_{dd}	5V supply		4.5		5.5	V
I_{Vdd}	5V supply	SPINDLE + VCM		6		mA
		SPINDLE ONLY		7		mA
		VCM ONLY		12		mA

ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
THERMAL SENSING						
T_{SD}	Shutdown Temperature		150		180	°C
T_{HYS}	Hysteresis			60		°C
T_{EW}	Early Warning			$T_{SD}-25$		°C
SUPPLY MONITOR						
V_{TR}	Trip Point	Input Rising	1.92	2	2.08	V
V_{HYS}	Hysteresis Voltage	Input falling		100		mV
I_{DLY}	Porb Delay Current	$TR_5V, TR_12V > V_{TR}$ $V_{pordly} = 2V$	1.5	2	2.5	μA
R_{on_por}	Porb Pull Down Ron	$V_{dd} > 2V$ and sink 1mA $V_{pordly} = 2V$			500	Ω
V_{DLY}	Porb Dly Threshold	$TR_5V, TR_12V > V_{TR}$	2.5	3.0	3.5	V
I_{IN}	Input Current	$V_{IN} < 4V$	-1		1	μA
VOLTAGE BOOST						
V_{BOOST}	Output Voltage		$V_{CC}+5$		$V_{CC}+6.3$	V
F_{OSC}	Internal Oscillator		130	200	250	kHz
SW1 OUTPUT						
R_{GATE}	Gate Driver for External Mosfet	Internal Resistor to CP		200		kΩ
V_{GATE}	Off Gate State Voltage for External Mosfet	$I_O = 1mA$ $V_{CC} = 3.5V$			0.7	V
DIGITAL LOGIC LEVELS						
V_{IH}	Input Logic "1"	$V_{DD} = 5.5V$	2.4			V
V_{IL}	Input Logic "0"	$V_{DD} = 4.5V$			0.5	V
V_{OH}	Output Logic "1"	$I_{SOURCE} = 20\mu A$	$V_{dd}-0.2$			V
V_{OL}	Output Logic "0"	$I_{SOURCE} = -400\mu A$			0.4	V
F_{SYSCLK}	System Clock			20	25	MHz
VCM, DAC						
	Resolution			14		Bits
	Differential Linearity	1 LSB Change -Tested By design	-1 -0.5		1 0.5	LSB
	Integral Linearity		9			Bits
	Midscale Offset	Referenced to $V_{CC}/2$	-5		5	mV
T_C	Conversion Time				5	μs
	Full Scale Voltage	Referenced to $V_{CC}/2$		±1		V
	Full Scale Error		-4		4	%
VCM, ERROR AMPLIFIER						
A_{VOL}	Open Loop Gain	DC	50			db
V_{OS}	Input Offset Voltage		-5		5	mV
I_{IB}	Input Bias Current		-250		250	nA

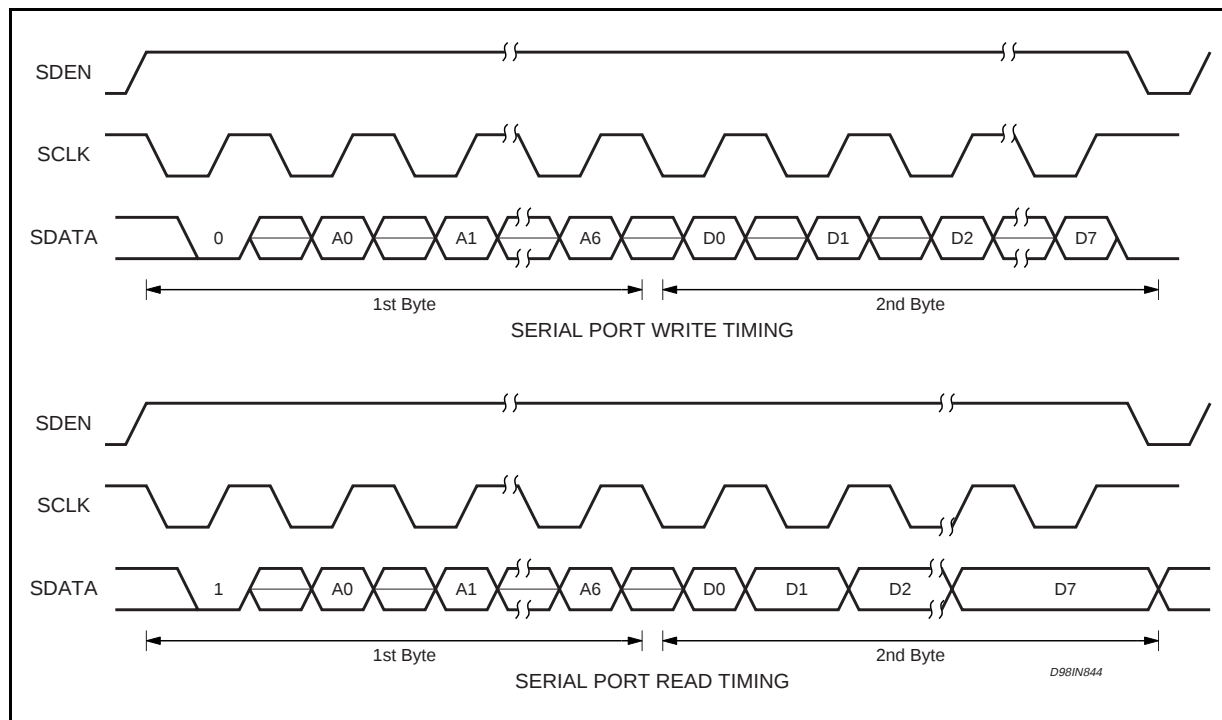
ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_{ICM}	Input Common Mode Range		$V_{CC}/2 - 0.5$		$V_{CC}/2 + 0.5$	V
V_{clamp}	Output Clamp Voltage	$-1mA < I_O < 1mA$ Lowside/Highside clamp		$V_{CC}/2 \pm 2.2V$		V
F_{ODB}	Unity Gain Bandwidth			10		MHz
VCM, POWER STAGE						
$R_{DS(ON)}$	Output ON Resistance (Each device)	$T_j = 25^\circ C$ $T_j = 125^\circ C$			0.5 0.8	Ω Ω
I_O	Operating Current				1.3	A
$I_{O(LEAK)}$	Output Leakage Current	$V_{CC} = 14V$			1.0	mA
VCM, CURRENT SENSE ANPLIFIER						
A_V	Voltage Gain		3.88	4	4.12	V/V
V_{ICM}	Input Common Mode Range		-0.3		$V_{CC} + 0.3$	V
V_{OCM}	Output Common Mode Range	$-3mA < I_O < 3mA$	2		$V_{CC} - 2$	V
V_{OS}	Output Offset Voltage	$SENSE_IN (\pm) = V_{CC}/2$	-15		15	mV
F_{3dB}	3dB Bandwidth			1		MHz
CMRR	Input Common Mode Rejection		50			dB
PSRR	Power Supply Rejection Ratio		60			dB
VCM, RETRACT						
V_{park}	RETRACT VOLTAGE	PKV_1 = 0 & PKV_2 = 0 PKV_1 = 0 & PKV_2 = 1 PKV_1 = 1 & PKV_2 = 0 PKV_1 = 1 & PKV_2 = 1		725 531 398 1080		mV mV mV mV
$T_{retract}$	Retract Time limited by the internal oscillator 200kHz	RT0 = 0 & RT1 = 0 RT0 = 0 & RT1 = 1 RT0 = 1 & RT1 = 0 RT0 = 1 & RT1 = 1		320 640 160 320		ms ms ms ms
SPINDLE, PWM CURRENT SENSE COMPARATOR						
T_{DLY}	Delay to FCOM Out			200	500	ns
SPINDLE, POWER STAGE						
$R_{DS(ON)}$	Output On Resistance (Each device)	$T_j = 25^\circ C$ $T_j = 125^\circ C$			0.45 0.74	Ω Ω
I_O	Start-Up Current				2	A
$I_{O(LEAK)}$	Output Leakage Current	$V_{CC} = 14V$			1.0	mA
dV_O/dt	Output Slew Rate (Linear)	$R_{slew} = 100k\Omega$	0.2	0.3	0.5	V/ μs
	Output Slew Rate (PWM)	Reg#8Eh, Bit 0 = 0 Reg#8Eh, Bit 0 = 1		10 20		V/ μs V/ μs
$BEMF_{MIN}$	Minimum BENF Voltage for Detection		20	28	40	mVp-p
V_{HYS}	Hysteresis			15		mV
FLL CHARGE PUMP OUTPUT						
I_{LEAK}	Off State Leakage	$0 < V_{fll_res}, 3V$	-50		+50	nA

ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
I _O	On State Current	FLL_RES = 62kΩ ICP = "1" ICP = "0"	22 80	25 100	32 120	μA μA
V _{RCP}	Current Set Voltage	FLL_RES = 62kΩ	1.18	1.225	1.25	V
CURRENT SENSE AMPLIFIER						
I _{BIAS}	Input Bias Current				2	μA
A _V	Voltage Gain		3.8	4.0	4.2	V/V
dV _O /d _t	Output Slew Rate			20		V/μs
SERIAL PORT						
Symbol	Parameter		Min.	Typ.	Max.	Unit
T _{SCK}	SCLK Period		40			ns
T _{CKL}	SCLK low time		15			ns
T _{CKH}	SCLK high time		15			ns
T _{SDENS}	Enable to SCLK		35			ns
T _{SDENH}	SCLK to disable		20			ns
T _{DS}	Data set-up time before rising edge SCLK		10			ns
T _{DH}	Data Hold Time		10			ns
T _{SDENL}	Minimum SDEN Low Time		50			ns
T _{SDV}	SCLK falling edge (A6) to SDATA valid on READ op.		3		10	ns
T _{SDV}	SCLK rising edge (D0-D7) to SDATA Transition on READ op.		5		35	ns

Figure 1. Serial Port Timing Information.

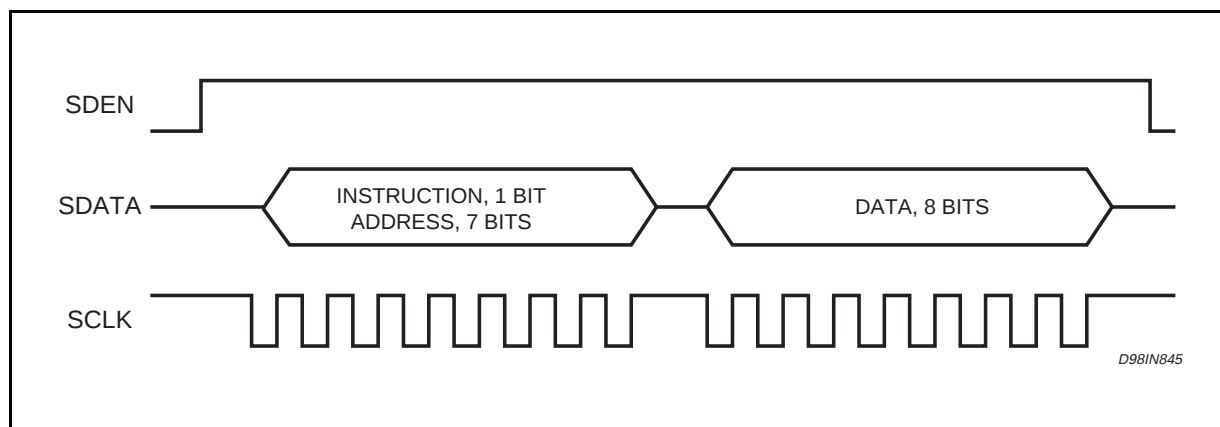


SERIAL PORT OPERATION

The serial port interface is a bi-directional port for reading and writing programming data from/to the internal registers of this device. For data transfers SDEN* is brought high, serial data is presented at the SDATA pin, and a serial clock is applied to the SCLK pin. After the SDEN* goes high, the first 16 pulses applied to the SCLK pin will shift the data presented at the SDATA pin into an internal shift register on the rising edge of each clock. An internal counter prevents more than 16 bits from being shifted into the register. The data in the shift register is latched after the 16th SCLK pulse. If less than 16 clock pulses are provided before SDEN* goes low, the data transfer is aborted.

All transfers are shifted into the serial port LSB first. The first byte of the transfer is for R/W and address and instruction information. The first bit is R/W instruction bit, 0 is for WRITE and 1 is for READ. Following 7 bits are Address.

Figure 2. Serial Port Data Transfer Format.



INTERNAL REGISTER DEFINITION

Reg: 0
 Name: VCM DAC (High) Register
 Type: Write only
 Address: 0Eh

BIT	LABEL	DESCRIPTION
0	VDAC BIT8	VCM DAC bit 8
1	VDAC BIT9	VCM DAC bit 9
2	VDAC BIT10	VCM DAC bit 10
3	VDAC BIT11	VCM DAC bit 11
4	VDAC BIT12	VCM DAC bit 12
5	VDAC BIT13	MSB resistor ladder of the 14 bit VCM DAC
6	PSM/LINEAR	Selects Voice Coil PSM or Linear Output Current Control. 1=PSM 0=Linear.
7	VCM_CAL	VCM calibration. 1 = Enables VCM control circuits and tristates VCM power transistors.

INTERNAL REGISTER DEFINITION**VCM DAC (High and Low) Registers**

Bit 0 through 5 of the VCM DAC (High) Registers and bit 0 through 7 of the VCM DAC (Low) Registers control the absolute value of the voice coil current. Bit is the sign bit, controlling the current direction. All the 13 bits are part of a resistor divider network.

Note. It is required to write on register 1 to make effective changes on register 0.

Reg:	1
Name:	VCM DAC (Low) Registers
Type:	Write only
Address:	1Eh

BIT	LABEL	DESCRIPTION
0	VDAC BIT0	LSB resistor ladder of the 14 bit VCM DAC
1	VDAC BIT1	VCM DAC bit 1
2	VDAC BIT2	VCM DAC bit2
3	VDAC BIT3	VCM DAC bit3
4	VDAC BIT4	VCM DAC bit4
5	VDAC BIT5	VCM DAC bit5
6	VDAC BIT6	VCM DAC bit6
7	VDAC BIT7	VCM DAC bit7

Reg:	2
Name:	Spindle Control Register
Type:	Write only
Address:	2Eh

BIT	LABEL	DESCRIPTION
0	INCRE_SEQ	A 0 to 1 transition of this bit increments the spindle Sequencer.
1	START_UP	1 = Spindle Internal start up, 0 = Spindle External start up
2	R_SEQ	Reset Spindle sequencer. 1 = Reset sequencer to phase 1.
3	RUN	1 = Start Spindle ALIGN & GO, 0 = Reset Spindle control logic.
4	SPIN_EN	Enable Spindle section. 1 = Enable, 0 = Disable.
5	MEC/ELEC	Specifies electrical or mechanical cycle for Spindle FLL control. 1=Electrical, 0 = Mechanical.
6	PWM/LINEAR	Selects Spindle PWM or Linear Output Current Control. 1 = PWM, 0=Linear.
7	EXT/INT	External or internal Spindle loop feedback. 1 = external feedback via index pin.

INTERNAL REGISTER DEFINITION

Reg: 3
Name: Spindle Delay Register
Type: Write only
Address: 3Eh

BIT	LABEL	DESCRIPTION			
0	MASK_TIME	Spindle BEMF Mask Time. 0 = 15 degree, 1 = 7.5 degree			
1	MIN2	Control Spindle PWM on time	Min 1	Min2	Min. on Time
			0	0	5.9μs
2	MIN1		0	1	1.4μs
			1	0	12μs
			1	1	5.21μs
3	8_12_POLE	Selects 8 or 12 pole motors. 1 = 8 pole, 0 = 12 pole.			
4	SD3	Spindle commutation delay MSB			
5	SD2	Spindle commutation delay bit			
6	SD1	Spindle commutation delay bit			
7	SD0	Spindle commutation delay LSB			

SPINDLE PHASE DELAY

SD3-0 set the phase delay from BEMF zero crossing to the next commutation. The 30 theoretical degree value can be changed to compensate for switching and other delays that are always present. The delay adjustment range is from 1.875 through to 30 electrical degrees in 1.875 degree increments.

Reg: 4
Name: FLL Coarse Counter Register
Type: Write only
Address: 4Eh

BIT	LABEL	DESCRIPTION
0	C4	Bit 4 of Spindle FLL Coarse Counter
1	C5	Bit 5 of Spindle FLL Coarse Counter
2	C6	Bit 6 of Spindle FLL Coarse Counter
3	C7	Bit 7 of Spindle FLL Coarse Counter
4	C8	Bit 8 of Spindle FLL Coarse Counter
5	C9	Bit 9 of Spindle FLL Coarse Counter
6	C10	Bit 10 of Spindle FLL Coarse Counter
7	C11	MSB of Spindle FLL Coarse Counter

INTERNAL REGISTER DEFINITION

Reg: 5
Name: FLL Coarse/Fine Counter Register
Type: Write only
Address: 5Eh

BIT	LABEL	DESCRIPTION
0	F8	Bit 8 of Spindle FLL Fine Counter
1	F9	Bit 9 of Spindle FLL Fine Counter
2	F10	MSB of Spindle FLL Fine Counter
3	2/3_PHASE	1 = 2 Phase Brake, 0 = 3 Phase Brake
4	C0	LSB of Spindle FLL Coarse Counter
5	C1	Bit 1 of Spindle FLL Coarse Counter
6	C2	Bit 2 of Spindle FLL Coarse Counter
7	C3	Bit 3 of Spindle FLL Coarse Counter

Reg: 6
Name: FLL Fine Counter Register
Type: Write only
Address: 6Eh

BIT	LABEL	DESCRIPTION
0	F0	LSB of Spindle FLL Fine Counter
1	F1	Bit 1 of Spindle FLL Fine Counter
2	F2	Bit 2 of Spindle FLL Fine Counter
3	F3	Bit 3 of Spindle FLL Fine Counter
4	F4	Bit 4 of Spindle FLL Fine Counter
5	F5	Bit 5 of Spindle FLL Fine Counter
6	F6	Bit 6 of Spindle FLL Fine Counter
7	F7	Bit 7 of Spindle FLL Fine Counter

INTERNAL REGISTER DEFINITION

Reg: 7
Name: Spindle Status Register
Type: Read only
Address: 7Eh

BIT	LABEL	DESCRIPTION
0	THERMAL	Thermal Shutdown = 0 indicates that the chip temperature has exceeded 160°C. The bit will reset (=1) when the temperature falls below 130°C. When Thermal Shutdown =0, the spindle logic will tristate both high and low side drivers, protecting the output circuitry.
1	THERM_WARN	Thermal Shutdown Warning =0 indicates that the chip temperature is approximately 25°C before the device goes in thermal shut down.
2	ROTOR_STUCK	0 = A sequential Spindle BEMF has not been detected
3	FAULT	1 = Rapid deceleration of the Spindle motor or High frequency on FCOM signal.
4	MASK_TIME	Mask Time toggled to "0" indicates that the Spindle BEMF is masked.
5	ERROR_LOCK	0 = Indicates error Spindle speed > 16msec/sample, either electrical or mechanical.
6	ALIGN	0 indicate that the Spindle is in the Internal Start-Up Align Phase.
7	GO	0 indicate that the Spindle is in the Internal Start-Up Go Phase.

Reg: 8
Name: Spindle FLL Register
Type: Write only
Address: 8Eh

BIT	LABEL	DESCRIPTION
0	SSLEW	Spindle PWM (chopping) Slew Rate. 0 = 10V μ S, 1 = 20V μ S
1	ICP	Spindle FLL Charge pump current. 1= 25 μ A, 0 = 100 μ A.
2		Unused. Set = 0.
3	ISNS	1 = Puts output of the Spindle sense amplifier on FCOM pin and changes limit to roughly 1/3 of normal.
4	IL1	Adjust maximum voltage on Spindle Rsense
5	IL0	Adjust maximum voltage on Spindle Rsense
6	CPL	1 = Spindle FLL Charge pump low
7	CPH	1 = Spindle FLL Charge pump high

"IL0"	"IL1"	"ISNS"	V(I_SENSE) LIMIT ($\pm 10\%$)
0	0	0	0.45V
1	0	0	0.50V
0	1	0	0.55V
1	1	0	0.75V
0	0	1	0.15V
1	0	1	0.20V
0	1	1	0.25V
1	1	1	0.30V

INTERNAL REGISTER DEFINITION

Reg:	9
Name:	System Control Register
Type:	Write only
Address:	9Eh

BIT	LABEL	DESCRIPTION
0	PKV_1	VCM Parking Voltage
1	PKV_2	VCM Parking Voltage
2	VR	1 = connects internal VR reference (2V) to level shift Opamp (for Vcm calibration).
3	RT0 (*)	VCM Retract Time
4	DOUBLE	1 = Spindle Internal Start-Up Align and Energization time doubled.
5	VCM_EN	Enable VCM section. 1 = Enable, 0 = Disable.
6	RT1 (*)	VCM Retract Time
7	RETRACT	1= VCM retract

"PKV_1"	"PKV_2"	"PARKING VOLTAGE"
0	0	0.725V
0	1	0.531V
1	0	0.398V
1	1	1.080V
"RT0"	"RT1"	"RETRACT TIME"
0	0	320ms
0	1	640ms
1	0	160ms
1	1	320ms

(*) When program Retract Time (RT0 and RT1), Bit 2 REG#8Eh must be always written to 0.

INTERNAL REGISTER DEFINITION

Reg:	10
Name:	Test Control Register
Type:	Write only
Address:	AEh

BIT	LABEL	DESCRIPTION
0		Unused. Set = 0
1		Unused. Set = 0
2		Unused. Set = 0
3		Unused. Set = 0
4	FLL_OUT	1 = Spindle Mech/Elec (see bit 5 register 2) output, 0 = Spindle zero crossing output.
5	REV_BRAKE	Spindle Reverse Brake command. 1 = Brake. "0" has to be reinserted to enable the spindle start up.
6		Unused. Set = 0
7	VB/DIS	1 = Disable Vboost

Reg:	11
Name:	VCM Control Register
Type:	Write only
Address:	BEh

BIT	LABEL	DESCRIPTION
0	VCMS	VCM PSM (chopping) Slew Rate. 0 = 10V/μs, 1 = 20V/μs
1	VCMH	1 = Forces VCM outputs to be High in PSM mode.
2	SLEEP	Unused (for future power saving mode).
3	COMSLEW	Spindle PWM (phase commutation) Slew Rate. 0 = 30Vμs, 1 = 2Vμs.
4		Unused. Set = 0
5		Unused. Set = 0
6		Unused. Set = 0
7		Unused. Set = 0

BIT	LABEL	DESCRIPTION
0	ID_REV_0	Minor Revision Bit 0.
1	ID_REV_1	Minor Revision Bit 1.
2	ID_REV_2	Minor Revision Bit 2.
3	ID_REV_3	Minor Revision Bit 3.
4	ID_REV_4	Minor Revision Bit 0.
5	ID_REV_5	Minor Revision Bit 1.
6	ID_REV_6	Minor Revision Bit 2.
7	ID_REV_7	Minor Revision Bit 3.

12V_VCC

STN4NE03

VCC

22μF 16V (1)

100nF

1μF

1N4148 47nF

CS

CP

1N4148

SW1

100nF

POR_DELAY

2.2μF

BRK_CAP

220pF(3)

PWM/SLEW

51K

DGND

5K(4)

SPN_COMP

10nF(4)

AGND

12V_VCC

5K(4)

TR_12V

15K

GND

VDD

5V_VDD

20K

22μF 16V (1)

100nF

18.2K

TR_5V

VCC

13.43

RSENSE

0.3(1W)

ISENSE

6.9

5

CTAP

2

OUT_A

10

OUT_B

7

OUT_C

4

26

VCM_A-

27

SENSE_IN+

0.25(1W)

30

VCM_A+

29

SENSE_IN-

FLL-FILTER

1μF

620K

21

FLL_RES

62K

100nF

32

VCC

25,31

INDEX

11

INDEX

1

FCOM

1

FCOM

34

PORB

4.7K

5V_VDD

PORB

15

SYS_CLK

15

SYS_CLK

18

SCLK

18

SCLK

17

SDATA

17

SDATA

16

SDEN

16

SDEN

22

VCM_CAL

20

V12/2

41

DAC

10K

ERROR_IN

39

ERROR_OUT

38

SENSE_OUT

62K

1nF

37

10K

37

VCM_GND

28

VCM_GND

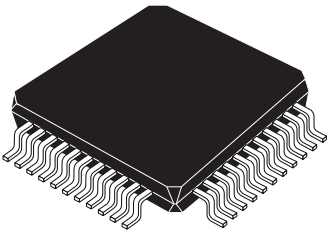
D99IN1049

⏏ Voice Coil Ground
 ⏏ Analog Ground
 ⏏ Power Ground
 ⏏ Digital Ground

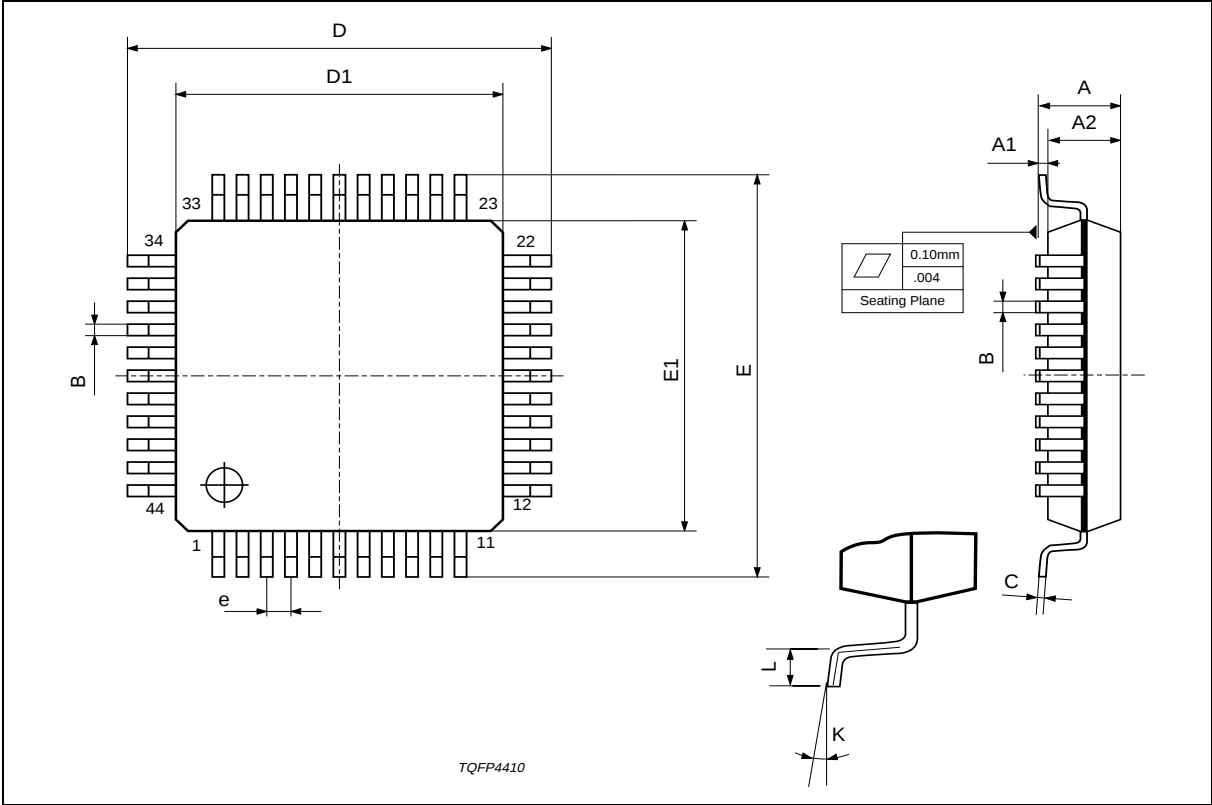
(1) This capacitor must be Tantalum
 (2) Place these components close to the device
 (3) Do not mount this component if Spindle Linear mode is used
 (4) Do not mount this component if Spindle Pwm mode is used

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.60			0.063
A1	0.05		0.15	0.002		0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
B	0.30	0.37	0.45	0.012	0.014	0.018
C	0.09		0.20	0.004		0.008
D		12.00			0.472	
D1		10.00			0.394	
D3		8.00			0.315	
e		0.80			0.031	
E		12.00			0.472	
E1		10.00			0.394	
E3		8.00			0.315	
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1.00			0.039	
K	0°(min.), 3.5°(typ.), 7°(max.)					

**OUTLINE AND
MECHANICAL DATA**



TQFP44 (10 x 10)



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